

## Features

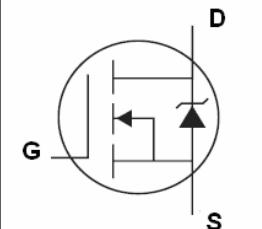
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ 100% Avalanche Tested
- ◆ Repetitive Avalanche Allowed up to  $T_{jmax}$
- ◆ Lead-Free, RoHS Compliant

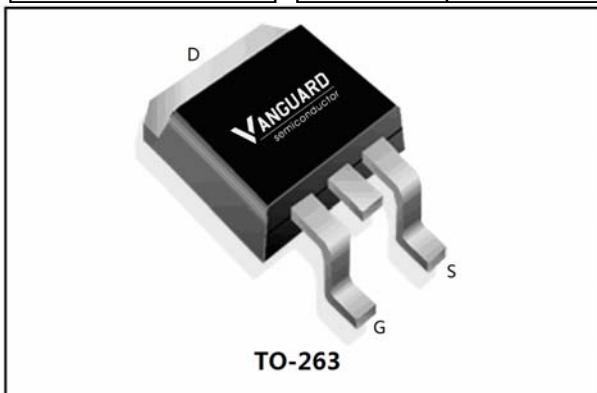
## Description

VS3107ATD designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Motor applications and a wide variety of other applications.

## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	$V_{DSS}$	80V
	$R_{DS(on)}$	3.0mΩ
	$I_D$	190A



Symbol	Parameter	Rating	Unit
<b>Common Ratings (T<sub>c</sub>=25°C Unless Otherwise Noted)</b>			
$V_{GS}$	Gate-Source Voltage	±25	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	80	V
$T_J$	Maximum Junction Temperature	175	°C
$T_{STG}$	Storage Temperature Range	-55 to 155	°C
$I_S$	Maximum Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A

## Mounted on Large Heat Sink

$I_{DM}$	Pulse Drain Current Tested ①	$T_c=25^\circ\text{C}$	750	A
$I_D$	Continuous Drain current@ $V_{GS}=10\text{V}$	$T_c=25^\circ\text{C}$	190	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	350	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		0.41	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		62.5	°C/W

## Drain-Source Avalanche Ratings

EAS	Avalanche Energy, Single Pulsed ②	950	mJ
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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_D=250\mu\text{A}$	80	85	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_c=25^\circ\text{C}$ )	$V_{\text{DS}}=75\text{V}$ , $V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_c=125^\circ\text{C}$ )	$V_{\text{DS}}=75\text{V}$ , $V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$	2.0	3.0	4.0	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance <sup>③</sup>	$V_{\text{GS}}=10\text{V}$ , $I_D=80\text{A}$	--	3.0	4.2	$\text{m}\Omega$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=15\text{A}$	--	50	--	S
<b>Dynamic Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=40\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	--	6250	--	pF
$C_{\text{oss}}$	Output Capacitance		--	1500	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	600	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=30\text{V}$ , $I_D=40\text{A}$ , $V_{\text{GS}}=10\text{V}$	--	150	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	30	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	40	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=40\text{V}$ , $I_D=1\text{A}$ , $R_G=6.8\Omega$ , $V_{\text{GS}}=10\text{V}$	--	26	--	nS
$t_r$	Turn-on Rise Time		--	180	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	50	--	nS
$t_f$	Turn-Off Fall Time		--	96	--	nS
<b>Source- Drain Diode Characteristics @ <math>T_J = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$I_{\text{SD}}$	Source-drain current(Body Diode)	$T_c=25^\circ\text{C}$	--	--	160	A
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=80\text{A}$ , $V_{\text{GS}}=0\text{V}$	--	0.84	1.3	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}$ , $I_{\text{sd}}=75\text{A}$ , $V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$	--	70	--	nS
$Q_{\text{rr}}$	Reverse Recovery Charge			125		nC

NOTE:

① Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ ; pulse width limited by max. junction temperature.

② Limited by  $T_{J\text{max}}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 60\text{A}$ ,  $V_{GS} = 10\text{V}$ .

### Typical Characteristics

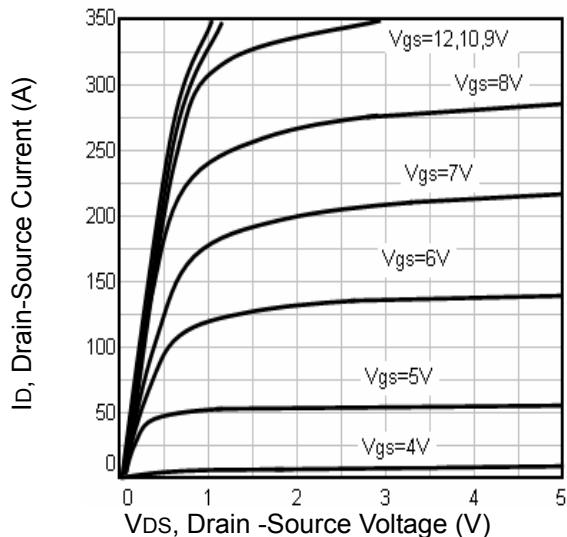


Fig1. Typical Output Characteristics

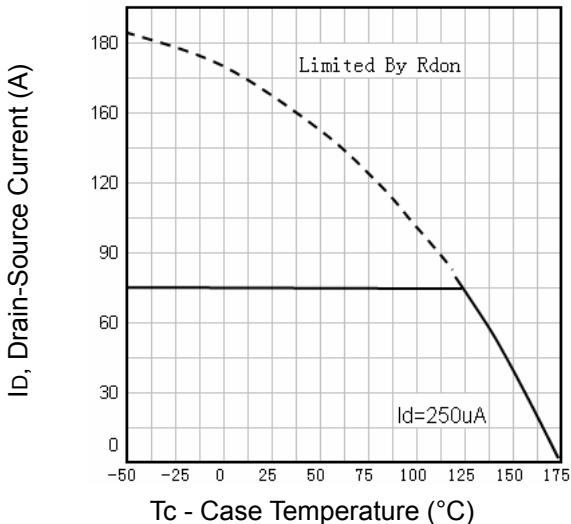


Fig2. Maximum Drain Current Vs. Case Temperature

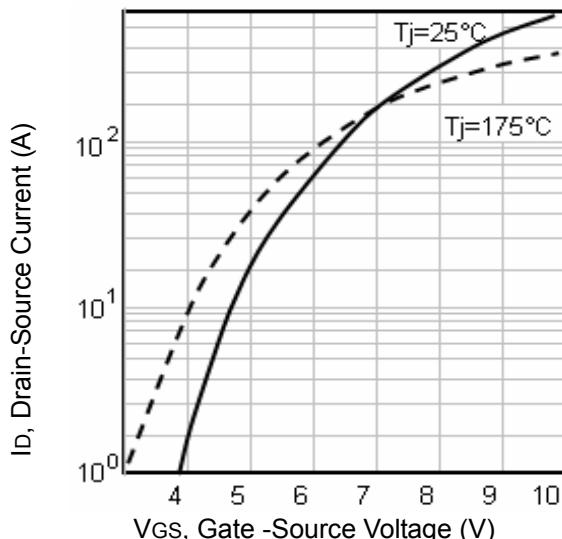


Fig3. Typical Transfer Characteristics

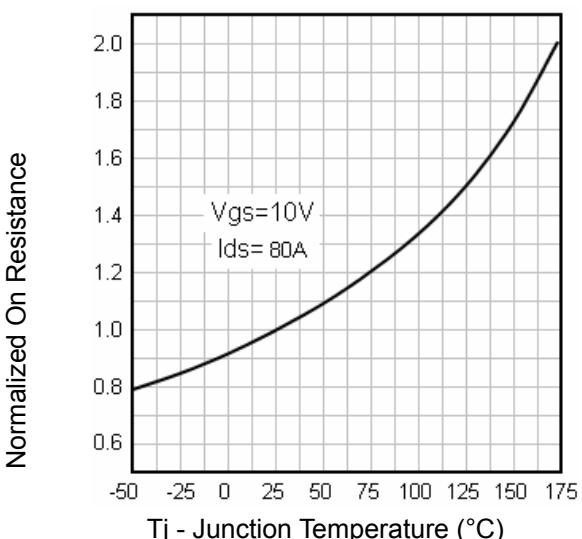


Fig4. Normalized On-Resistance Vs. Temperature

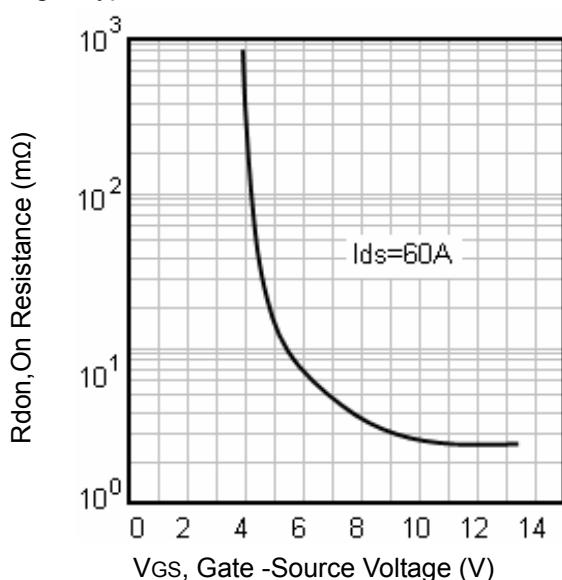


Fig5. Typical Forward Transconductance Vs. Drain Current

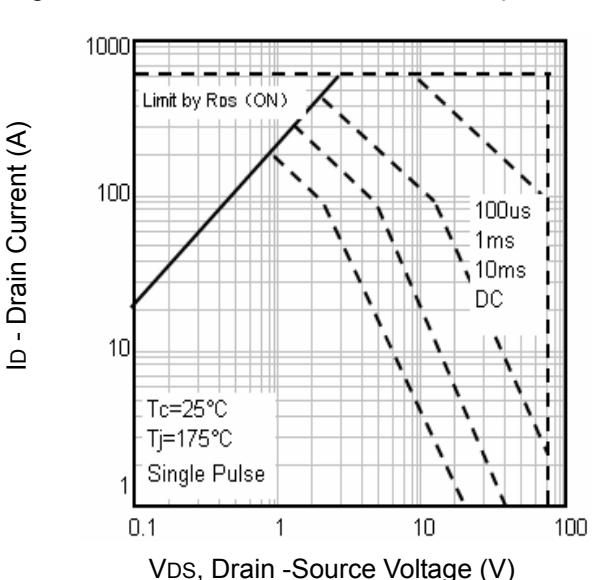


Fig6. Maximum Safe Operating Area

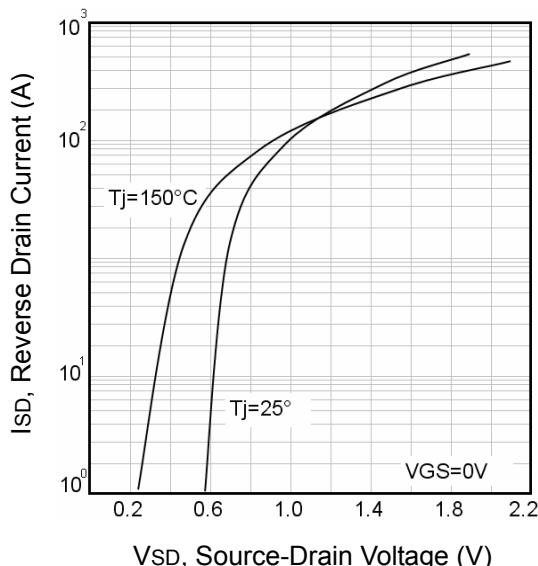


Fig7. Typical Source-Drain Diode Forward Voltage

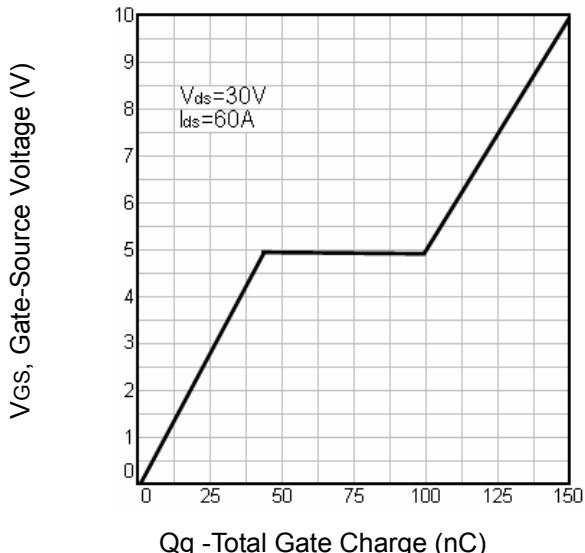


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

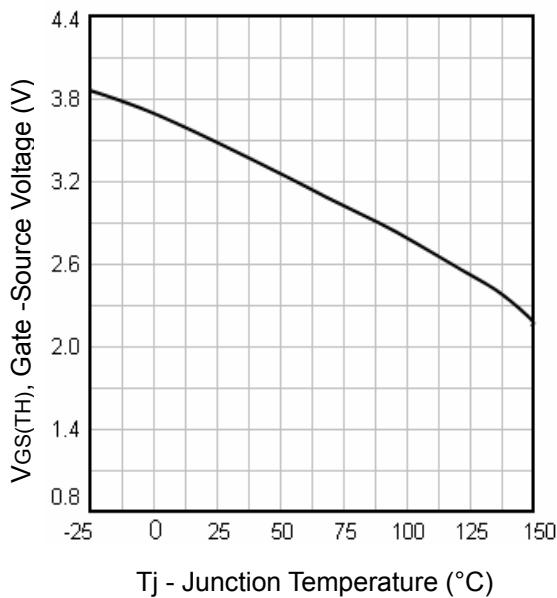


Fig9. Threshold Voltage Vs. Temperature

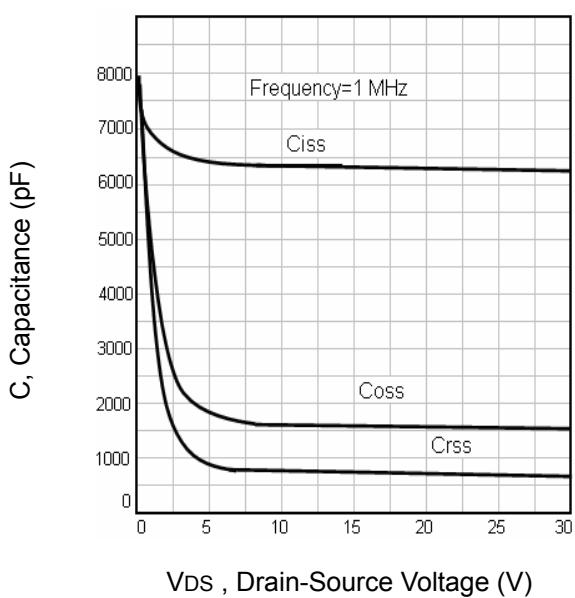


Fig10. Typical Capacitance Vs.Drain-Source Voltage

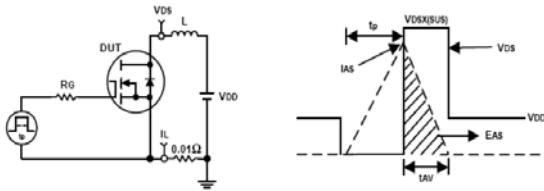


Fig11. Unclamped Inductive Test Circuit and waveforms

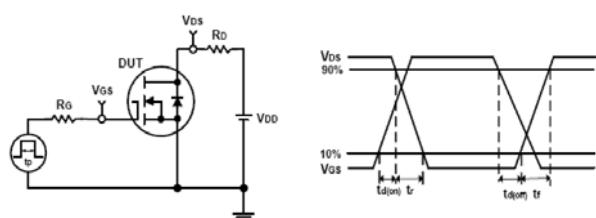
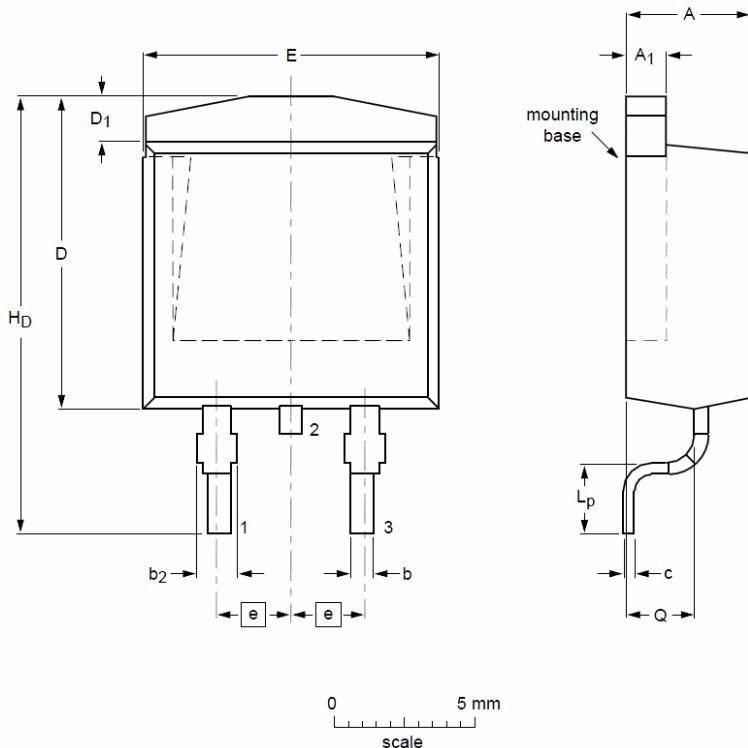


Fig12. Switching Time Test Circuit and waveforms

## TO-263 Package Outline



**DIMENSIONS ( unit : mm )**

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	4.10	4.40	4.50	A <sub>1</sub>	1.27	1.32	1.40
b	0.60	0.76	0.85	b <sub>2</sub>	1.05	1.30	1.45
c	0.46	0.54	0.64	D	10.20	10.40	11.00
D <sub>1</sub>	1.20	1.51	1.60	E	9.70	10.10	10.30
e	--	2.54	--	H <sub>D</sub>	14.80	15.45	15.80
L <sub>P</sub>	2.10	2.40	2.90	Q	2.20	2.50	2.60

## Order Information

Product	Marking	Package	Packaging	Min Unit Quantity
VS3107ATD	VS3107ATD	TO-263	800PCS/Reel	800PCS

## Customer Service

### Sales and Service:

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